



SPECIFICATIONS

Rated Current:3.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:1000V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40°C to +105°C

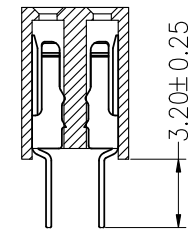
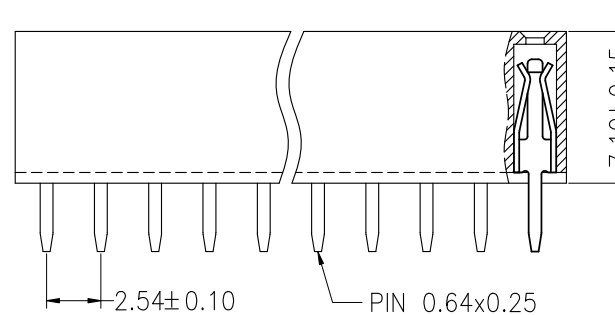
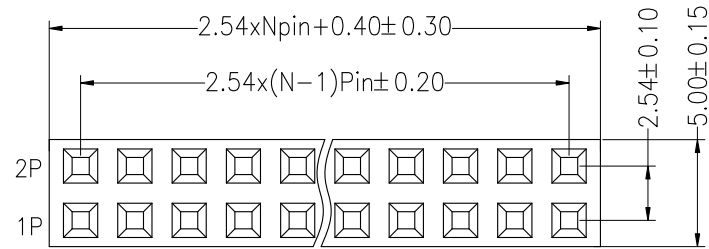
Contact Material:Copper Alloy

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 260°C±5°C 5S



Ordering Information

2271 02 XX X N XX S U X XX

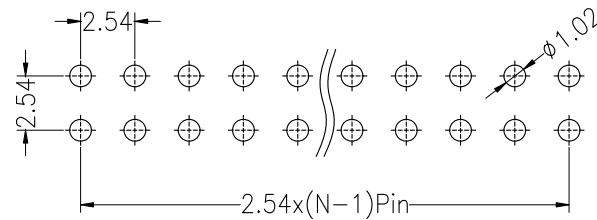
No. of Pins
Per Row
02~40P

Insulator Material
Option
A=BK-PBT
C=BK-PA6T
E=BK-PA9T
F=BK-LCP

Contact Plating
G1:Gold Flash
G2:1.5u" Gold
G3:2u" Gold
G4:3u" Gold
G5:5u" Gold
G6:10u" Gold
G7:15u" Gold
G8:30u" Gold
S0:Gold Flash/Tin
SN:Tin

Packing
0=PE Bag
A=Tray
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

code stream
01~99



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

				OPERATION		DRAW	ChenWei	20.12.10	SCALE	FIT	JILN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				UNIT	mm		
A	A0	2020.12.10	NEW DRAWING	X.XX	±0.20	CHECK			SIZE	A4	PART NO.	227102XXXXXSUXXX
				X.XXX	±0.10				SHEET	1/1		
				Angle	±3°	APPROVE			PROJ.	Φ	TITLE:	2.54PF H7.1mm 2xNpin 180° DIP
	REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL						

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